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Sharp Microelectronics PC452

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PC452 Series

PC452 Series

Mini-flat Package, Darlinton Phototransistor Output, High Collector-emitter Voltage Photocoupler



Description

PC452 Series contains an IRED optically coupled to a phototransistor.

It is packaged in a 4-pin Mini-flat.

Input-output isolation voltage(rms) is 3.75kV.

Collector-emitter voltage is 350V and CTR is MIN.

1 000% at input current of 1.0mA.

Features

- 1. 4-pin Mini-flat package
- Double transfer mold package (Ideal for Flow Soldering)
- 3. High collector-emitter voltage (V_{CEO} : 350V)
- 4. Darlington phototransistor output (CTR : MIN. 1 000% at I_F=1mA, V_{CE}=2V)
- 5. High isolation voltage between input and output $(V_{iso(rms)}: 3.75 kV)$

■ Agency approvals/Compliance

- 1. Recognized by UL1577 (Double protection isolation), file No. E64380 (as model No. **PC452**)
- 2. Package resin : UL flammability grade (94V-0)

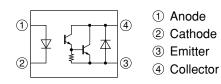
Applications

- 1. Telephone sets
- 2. Copiers, facsimiles
- 3. Interfaces with various power supply circuits, power distribution boards
- 4. Hybrid substrates which reguire high density mounting

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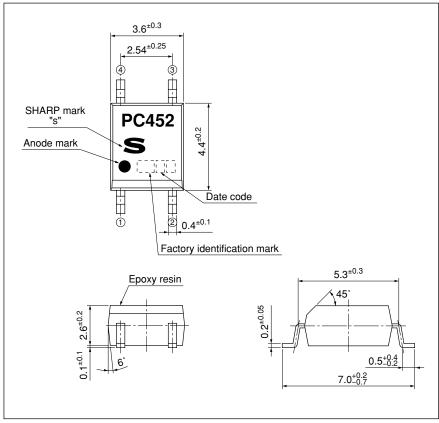


■ Internal Connection Diagram



Outline Dimensions





Product mass : approx. 0.1g



Date code (2 digit)

1st digit				2nd digit		
	Year of p	roduction		Month of production		
A.D.	Mark	A.D	Mark	Month	Mark	
1990	А	2002	Р	January	1	
1991	В	2003	R	February	2	
1992	С	2004	S	March	3	
1993	D	2005	Т	April	4	
1994	Е	2006	U	May	5	
1995	F	2007	V	June	6	
1996	Н	2008	W	July	7	
1997	J	2009	X	August	8	
1998	K	2010	Α	September	9	
1999	L	2011	В	October	0	
2000	М	2012	С	November	Ν	
2001	N	:	:	December	D	

repeats in a 20 year cycle

Factory identification mark

Factory identification Mark	Country of origin	
no mark	Ionor	
	Japan	
	Indonesia	
$\overline{}$	Philippines	
	China	

* This factory marking is for identification purpose only. Please Contact the local SHARP sales reprsentative to see the actual status of the production.



	■ Absolute Maximum Ratings (T _a =25°C)						
	Parameter	Symbol	Rating	Unit			
t	Forward current	I _F	50	mA			
Input	Reverse voltage	V _R	6	V			
Ĥ	Power dissipation	Р	70	mW			
	Collector-emitter voltage	V _{CEO}	350	V			
Output	Emitter-collector voltage	V _{ECO}	0.1	V			
Out	Collector current	I _C	150	mA			
	Collector power dissipation	P _C	150	mW			
	Fotal power dissipation	P _{tot}	170	mW			
(Operating temperature	T _{opr}	-30 to +100	°C			
Ś	Storage temperature	T _{stg}	-40 to +125	°C			
*1]	solation voltage	V _{iso (rms)}	3.75	kV			
*2 🤅	Soldering temperature	T _{sol}	260	°C			

*1 40 to 60%RH, AC for 1 minute, f=60Hz

*2 For 10s

■ Electro-optical Characteristics

 $(T_a=25^{\circ}C)$

	-					(14 =0 0)		
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
	Forward voltage		$V_{\rm F}$	I _F =10mA	-	1.2	1.4	V
Input	Reverse Current		I _R	V _R =4V	-	-	10	μΑ
	Terminal capacitance		Ct	V=0, f=1kHz	-	30	250	pF
Outrout	Collector dark current		I _{CEO}	$V_{CE}=200V, I_{F}=0$	-	_	200	nA
Output	Collector-emitter breakdown voltage		BV_{CEO}	$I_{C}=0.1 \text{mA}, I_{F}=0$	350	-	-	V
	Collector current		I _C	$I_F=1mA$, $V_{CE}=2V$	10	_	_	mA
	Collector-emitter saturation voltage		V _{CE (sat)}	$I_F=20mA$, $I_C=100mA$	-	_	1.2	V
Transfer charac- teristics	Isolation resistance		R _{ISO}	DC500V, 40 to 60%RH	5×10 ¹⁰	1×10 ¹¹	-	Ω
	Floating capacitance		C _f	V=0, f=1MHz	-	0.6	1.0	pF
	Cut-off frequency		$\mathbf{f}_{\mathbf{C}}$	$V_{CE}=2V, I_{C}=20mA, R_{L}=100\Omega, -3dB$	1	7	_	kHz
	Decompose time	Rise time	t _r	N. N. L. 20, A. D. 1000	-	100	300	μs
	Response time Fall time		$t_{\rm f}$	$V_{CE}=2V$, $I_C=20mA$, $R_L=100\Omega$	_	20	100	μs



■ Model Line-up

Dealrage	Taping			
Package	3 000 pcs/reel	750 pcs/reel		
Model No.	PC452	PC452T		

Please contact a local SHARP sales representative to inquire about production status and Lead-Free options.



PC452 Series

Fig.1 Forward Current vs. Ambient

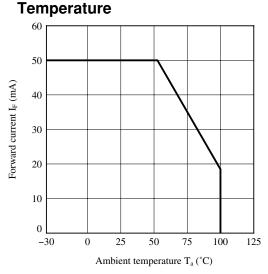
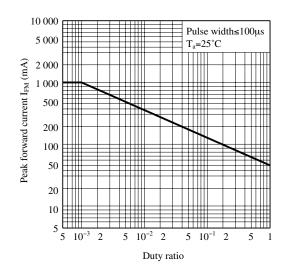


Fig.3 Peak Forward Current vs. Duty Ratio





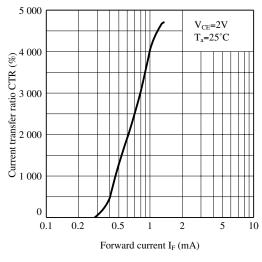


Fig.2 Collector Power Dissipation vs. Ambient Temperature

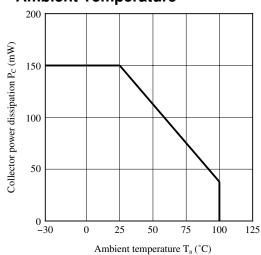


Fig.4 Forward Current vs. Forward Voltage

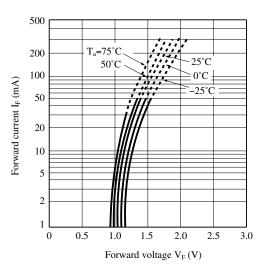
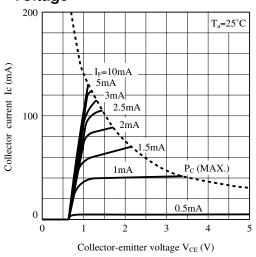


Fig.6 Collector Current vs. Collector-emitter Voltage



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Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

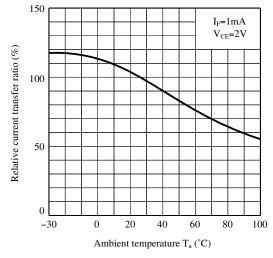


Fig.9 Collector Dark Current vs. Ambient Temperature

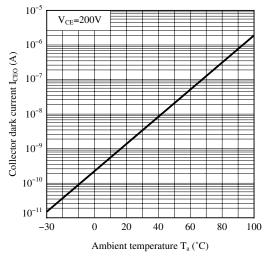
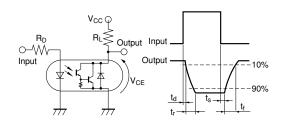
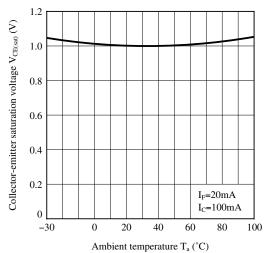


Fig.11 Test Circuit for Response Time



Please refer to the conditions in Fig.10

Fig.8 Collector - emitter Saturation Voltage vs. Ambient Temperature





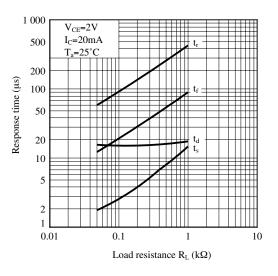
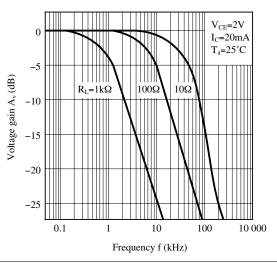


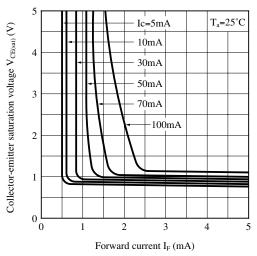
Fig.12 Frequency Response



Sheet No.: D2-A00901EN



Fig.13 Collector-emitter Saturation Voltage vs. Forward Current



Remarks : Please be aware that all data in the graph are just for reference and not for guarantee.



Design Considerations

• Design guide

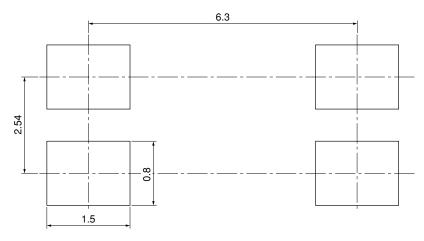
While operating at $I_F < 1.0$ mA, CTR variation may increase. Please make design considering this fact.

This product is not designed against irradiation and incorporates non-coherent IRED.

Degradation

In general, the emission of the IRED used in photocouplers will degrade over time. In the case of long term operation, please take the general IRED degradation (50% degradation over 5years) into the design consideration.

Recommended Foot Print (reference)



(Unit : mm)

* For additional design assistance, please review our corresponding Optoelectronic Application Notes.

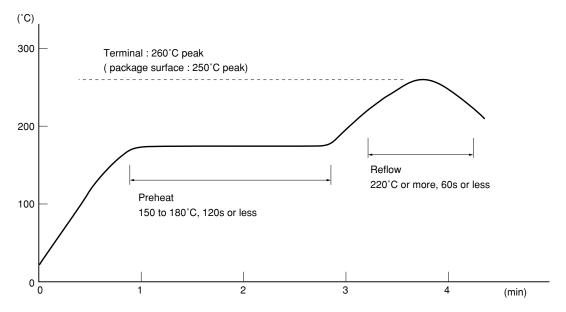


■ Manufacturing Guidelines

Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below. Soldering should not exceed the curve of temperature profile and time. Please don't solder more than twice.



Flow Soldering :

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 260°C and within 10s. Preheating is within the bounds of 100 to 150°C and 30 to 80s. Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C. Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



• Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below Immersion time should be 3minutes or less

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances:CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform) Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



Package specification

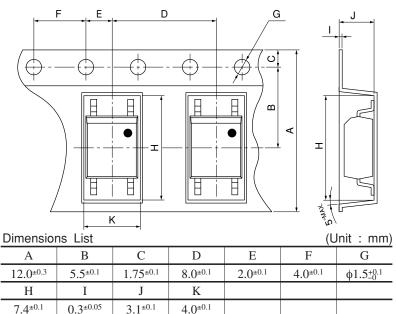
• Tape and Reel package

- 1. 3 000pcs/reel
- Package materials

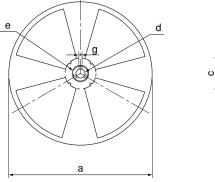
Carrier tape : A-PET (with anti-static material)

- Cover tape : PET (three layer system)
- Reel : PS

Carrier tape structure and Dimensions

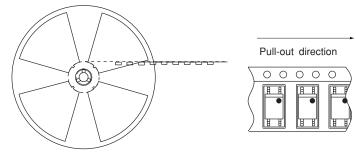


Reel structure and Dimensions



Dimensio	na Liat	(1.1		
Dimensio	IIS LISI	(Unit : mm)		
а	b	с	d	
370	13.5 ^{±1.5}	80 ^{±1.0}	13 ^{±0.5}	
e	f	g		
21 ^{±1.0}	2.0 ^{±0.5}	2.0 ^{±0.5}		

Direction of product insertion



b

[Packing : 3 000pcs/reel]



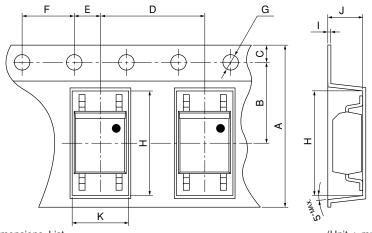
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2. 750 pcs / reel

Package materials Carrier tape : A-PET (with anti-static material) Cover tape : PET (three layer system)

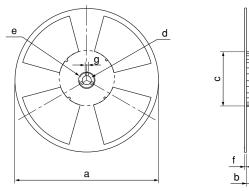
Reel : PS

Carrier tape structure and Dimensions



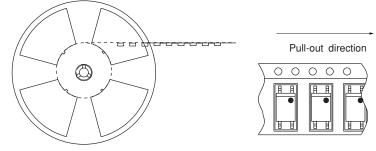
Dimensions List						(Unit : mm)
А	В	С	D	Е	F	G
$12.0^{\pm 0.3}$	$5.5^{\pm 0.1}$	$1.75^{\pm 0.1}$	$8.0^{\pm 0.1}$	$2.0^{\pm 0.1}$	$4.0^{\pm 0.1}$	φ1.5 ^{+0.1}
Н	Ι	J	K			
$7.4^{\pm 0.1}$	$0.3^{\pm 0.05}$	$3.1^{\pm 0.1}$	$4.0^{\pm 0.1}$			

Reel structure and Dimensions



Dimensio	ns List	(Unit : mm)		
а	b	с	d	
180	13.5 ^{±1.5}	80 ^{±1.0}	13 ^{±0.5}	
e	f	g		
21 ^{±1.0}	2.0 ^{±0.5}	2.0 ^{±0.5}		

Direction of product insertion



[Packing : 750pcs/reel]



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- --- Personal computers
- --- Office automation equipment
- --- Telecommunication equipment [terminal]
- --- Test and measurement equipment
- --- Industrial control
- --- Audio visual equipment
- --- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:

- --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- --- Space applications
- --- Telecommunication equipment [trunk lines]
- --- Nuclear power control equipment
- --- Medical and other life support equipment (e.g., scuba).

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